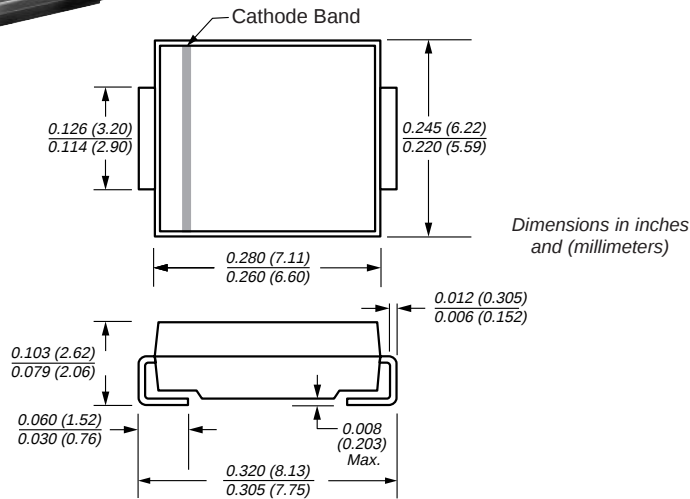


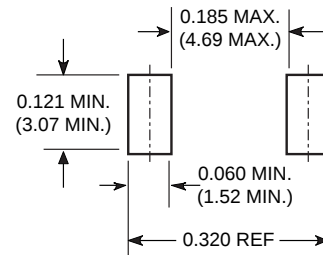


Surface Mount Fast Switching Rectifier

DO-214AB (SMC)

Reverse Voltage 50 to 800V
Forward Current 3.0A

Mounting Pad Layout



Mechanical Data

Case: JEDEC DO-214AB molded plastic over glass passivated chip**Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026**Polarity:** Color band denotes cathode end**Weight:** 0.007 oz., 0.25 g**Packaging codes/options:**

9/3.5K per 13" Reel (16mm Tape)

7/850 EA per 7" Reel (16mm Tape)

Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Low profile surface mount package
- Built-in strain relief
- Fast switching for high efficiency
- Easy pick and place
- Glass passivated chip junction
- High temperature soldering: 250°C/10 seconds at terminals

Maximum Ratings & Thermal Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameters	Symbols	RS3A	RS3B	RS3D	RS3G	RS3J	RS3K	Units
Device marking code		RA	RB	RD	RG	RJ	RK	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	500	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	V
Maximum average forward rectified current at T _L =75°C	I _{F(AV)}	3.0						A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) T _L =75°C	I _{FSM}	100						A
Typical thermal resistance ⁽¹⁾	R _{θJA} R _{θJL}	50 15						°C/W
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150						°C

Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Maximum instantaneous forward voltage at 2.5A	V _F	1.3						V
Maximum DC reverse current at rated DC blocking voltage T _A =25°C T _A =125°C	I _R	10 250						μA
Maximum reverse recovery time I _F =0.5A, I _R =1.0A, I _{rr} =0.25A	t _{rr}	150			250	500		ns
Typical junction capacitance at 4.0V, 1MHz	C _J	60						pF

Notes: (1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad area

Ratings and Characteristic Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 1 — Forward Current Derating Curve

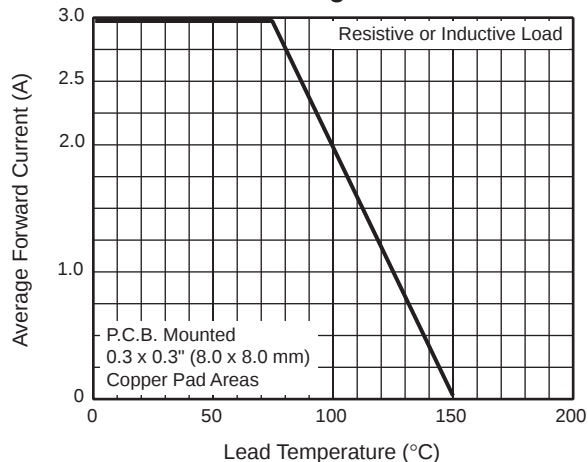


Fig. 2 — Maximum Non-Repetitive Peak Forward Surge Current

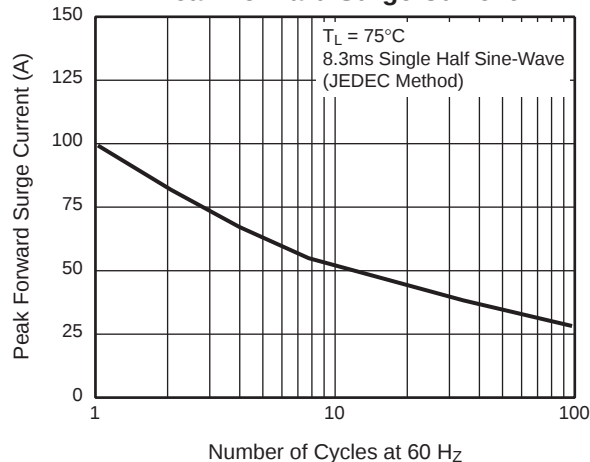


Fig. 3 — Typical Instantaneous Forward Characteristics

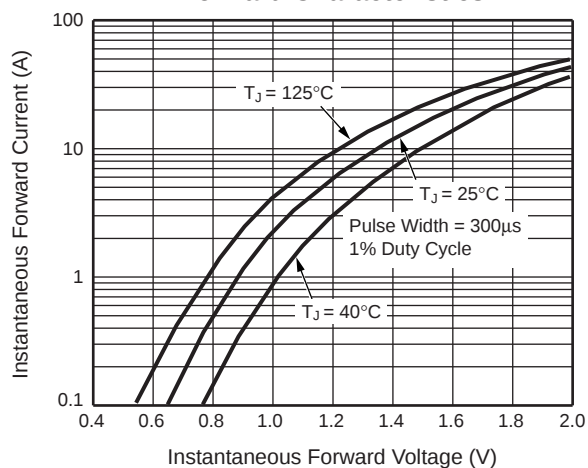


Fig. 4 — Typical Reverse Characteristics

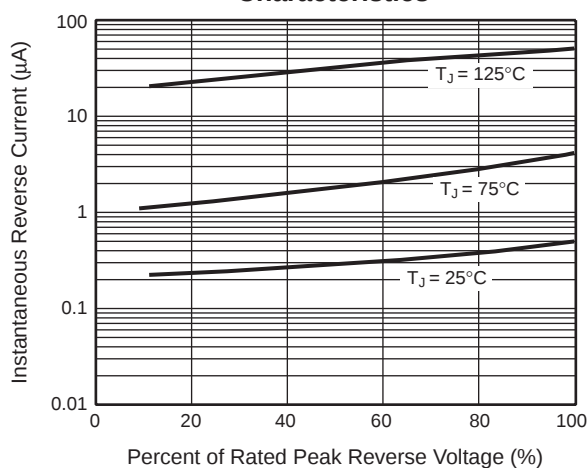


Fig. 5 — Typical Transient Thermal Impedance

